

HF71765

[10191/1629]

## REPLY UNDER 37 C.F.R. § 1.116 EXPEDITED PROCEDURE GROUP ART UNIT 1765

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s)

Franz LAERMER et al.

Serial No.

09/720,761

Filed

March 26, 2001

For

METHOD OF PLASMA ETCHING OF SILICON

Examiner

Kin Chan Chen

Art Unit

1765

Mail Stop AF

Commissioner for Patents P. O. Box 1450

Alexandria, VA 22313-1450

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Mail Stop AF Commissioner for Patents, P. O. Box/1450, Alexandria, VA 22313-1450

Date:

Reg. No. 22,490

Signature:

Richard La Mager

## **TRANSMITTAL**

SIR:

Transmitted herewith for filing in the above-identified application is a Reply Under 37 C.F.R. § 1.116 and a certified copy of German Application 199 19 469.6.

No fee is believed to be required. However, if any fee is required, please use Deposit Account No. **11-0600**. A duplicate copy of this transmittal letter is enclosed for that purpose.

Respectfully submitted,

Dated:  $\frac{\epsilon/5/\ell3}{}$ 

Βv

Richard L. Mayer

Reg. No. 22,490

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PATENT TRADEMARK OFFICE

KENYON & KENYON One Broadway New York, New York 10004 (212) 425-7200